

# GP1S56T

## Compact, High Sensing Accuracy Type Photointerrupter with Positioning Pin

### ■ Features

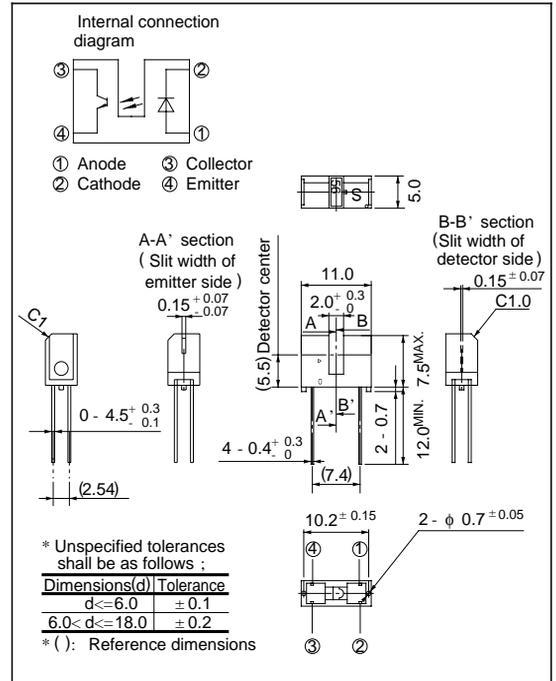
1. High sensing accuracy (Slit width : 0.15mm)
2. Compact (Case height : 7.5mm)
3. With positioning pin
4. PWB direct mounting type

### ■ Applications

1. Floppy disk drives
2. VCRs, cassette decks
3. Optoelectronic switches

### ■ Outline Dimensions

(Unit : mm)



### ■ Absolute Maximum Ratings

(Ta = 25°C)

Parameter		Symbol	Rating	Unit
Input	Forward current	I <sub>F</sub>	50	mA
	*1 Peak forward current	I <sub>FM</sub>	1	A
	Reverse voltage	V <sub>R</sub>	6	V
	Power dissipation	P	75	mW
Output	Collector-emitter voltage	V <sub>CEO</sub>	35	V
	Emitter-collector voltage	V <sub>ECO</sub>	6	V
	Collector current	I <sub>C</sub>	20	mA
	Collector power dissipation	P <sub>C</sub>	75	mW
Operating temperature		T <sub>opr</sub>	- 25 to + 85	°C
Storage temperature		T <sub>stg</sub>	- 40 to + 100	°C
*2 Soldering temperature		T <sub>sol</sub>	260	°C

\*1 Pulse width ≤ 100 μs, Duty ratio = 0.01

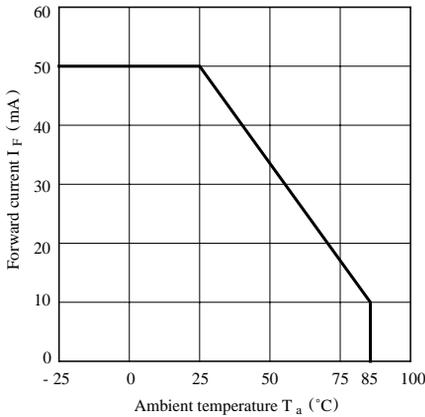
\*2 For 5 seconds

**■ Electro-optical Characteristics**

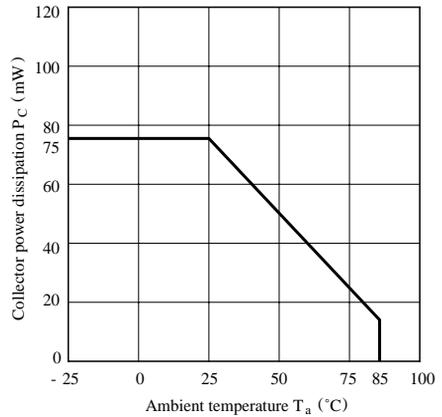
( $T_a = 25^\circ\text{C}$ )

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage	$V_F$	$I_F = 20\text{mA}$	-	1.2	1.4	V
	Peak forward voltage	$V_{FM}$	$I_{FM} = 0.5\text{A}$	-	3	4	V
	Reverse current	$I_R$	$V_R = 3\text{V}$	-	-	10	$\mu\text{A}$
Output	Collector dark current	$I_{CEO}$	$V_{CE} = 20\text{V}$	-	1	100	nA
Transfer characteristics	Collector Current	$I_C$	$V_{CE} = 5\text{V}, I_F = 20\text{mA}$	0.4	-	-	mA
	Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_F = 40\text{mA}$ $I_C = 0.25\text{mA}$	-	-	0.4	V
	Response time	Rise time	$t_r$	$V_{CE} = 2\text{V}, I_C = 0.5\text{mA}$ $R_L = 1\text{K}\Omega$	-	38	90
Fall time		$t_f$	-		48	110	$\mu\text{s}$

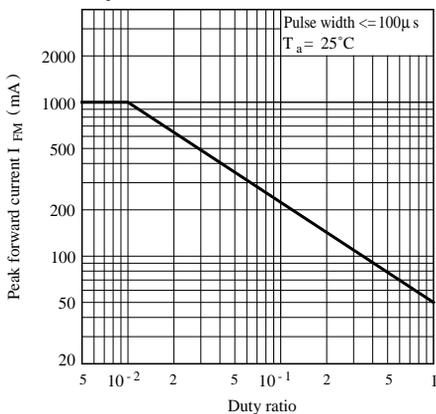
**Fig. 1 Forward Current vs. Ambient Temperature**



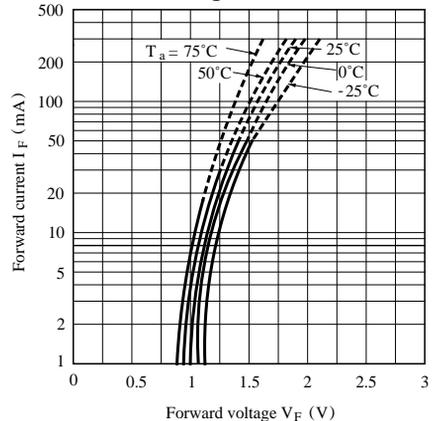
**Fig. 2 Collector Power Dissipation vs. Ambient Temperature**



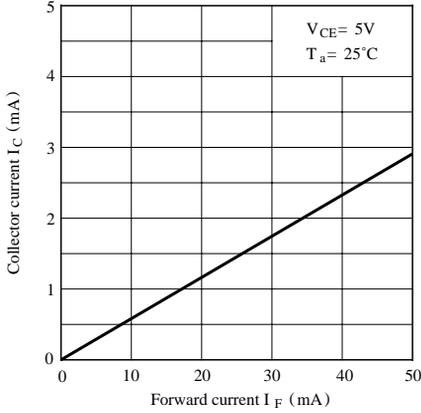
**Fig. 3 Peak Forward Current vs. Duty Ratio**



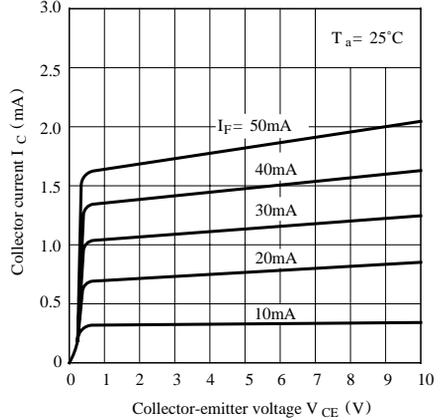
**Fig. 4 Forward Current vs. Forward Voltage**



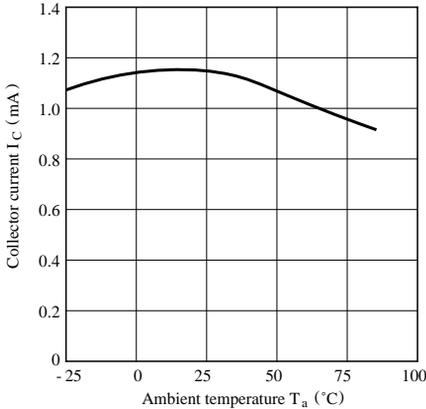
**Fig. 5 Collector Current vs. Forward Current**



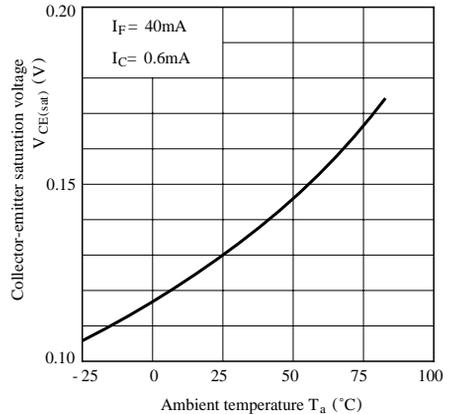
**Fig. 6 Collector Current vs. Collector-emitter Voltage**



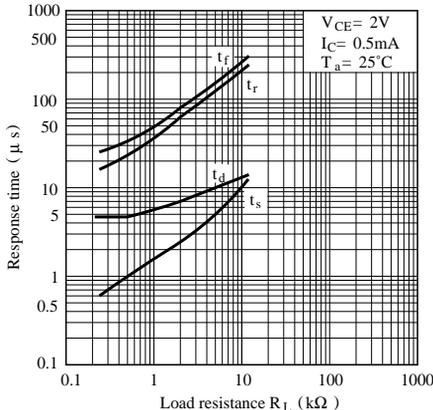
**Fig. 7 Collector Current vs. Ambient Temperature**



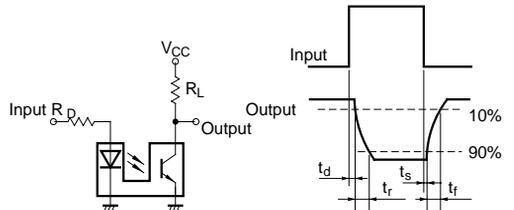
**Fig. 8 Collector-emitter Saturation Voltage vs. Ambient Temperature**



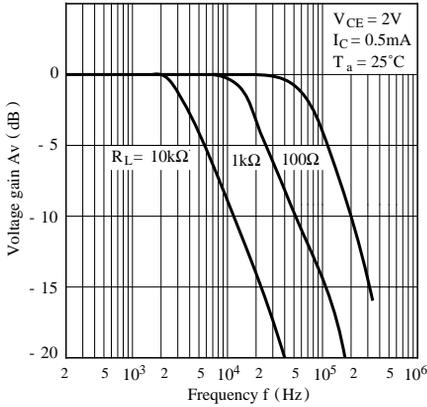
**Fig. 9 Response Time vs. Load Resistance**



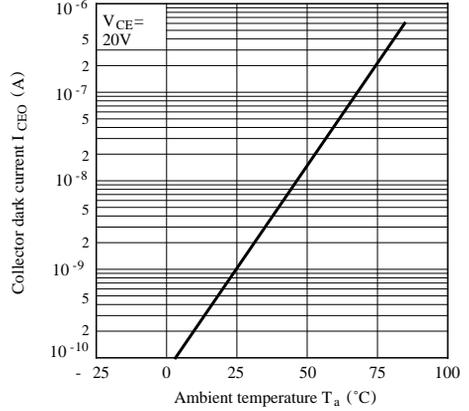
**Test Circuit for Response Time**



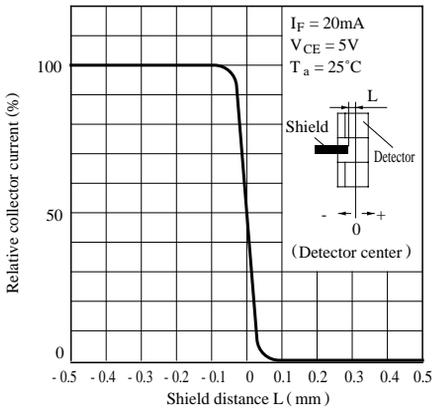
**Fig.10 Frequency Response**



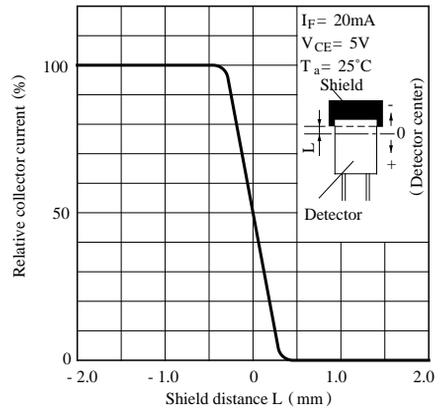
**Fig.11 Collector Dark Current vs. Ambient Temperature**



**Fig.12 Relative Collector Current vs. Shield Distance (1)**



**Fig.13 Relative Collector Current vs. Shield Distance (2)**



**■ Precautions for Use**

- (1) In case of cleaning, use only the following type of cleaning solvent.  
 Ethyl alcohol, methyl alcohol, isopropyl alcohol
- (2) As for other general cautions, refer to the chapter “Precautions for Use”.

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